

2A, 200V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.029g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	2	A
V_{RRM}	200 - 1000	V
I_{FSM}	50	A
$T_{J\ MAX}$	150	°C
Package	Thin SMA	
Configuration	Single die	



Thin SMA



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)								
PARAMETER	SYMBOL	RS2DAL	RS2GAL	RS2JAL	RS2KAL	RS2MAL	UNIT	
Marking code on the device		RS2DAL	RS2GAL	RS2JAL	RS2KAL	RS2MAL		
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V	
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V	
Forward current	I_F	2					A	
Surge peak forward current single half sine wave superimposed on rated load	t = 8.3ms	I_{FSM}					50	A
	t = 1.0ms						140	A
Junction temperature	T_J	-55 to +150					°C	
Storage temperature	T_{STG}	-55 to +150					°C	

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	16	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	73	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	14	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
Forward voltage ⁽¹⁾	RS2DAL RS2GAL RS2JAL	V_F	$I_F = 1.0\text{A}, T_J = 25^\circ\text{C}$	0.93	-	V
			$I_F = 2.0\text{A}, T_J = 25^\circ\text{C}$	1.01	1.30	V
			$I_F = 1.0\text{A}, T_J = 125^\circ\text{C}$	0.78	-	V
			$I_F = 2.0\text{A}, T_J = 125^\circ\text{C}$	0.88	1.02	V
	RS2KAL RS2MAL		$I_F = 1.0\text{A}, T_J = 25^\circ\text{C}$	0.98	-	V
			$I_F = 2.0\text{A}, T_J = 25^\circ\text{C}$	1.06	1.30	V
			$I_F = 1.0\text{A}, T_J = 125^\circ\text{C}$	0.83	-	V
			$I_F = 2.0\text{A}, T_J = 125^\circ\text{C}$	0.93	1.05	V
Reverse current @ rated V_R ⁽²⁾	$T_J = 25^\circ\text{C}$	I_R	-	1	μA	
	$T_J = 125^\circ\text{C}$		-	40	μA	
Reverse recovery time	RS2DAL RS2GAL	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$	t_{rr}	-	150	ns
	RS2JAL			-	250	ns
	RS2KAL RS2MAL			-	500	ns
Junction capacitance	RS2DAL RS2GAL RS2JAL	1MHz, $V_R = 4.0\text{V}$	C_J	11	-	pF
	RS2KAL RS2MAL			10	-	pF

Notes:

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
RS2xAL	Thin SMA	14,000 / Tape & Reel

Notes:

1. "x" defines voltage from 200V(RS2DAL) to 1000V(RS2MAL)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

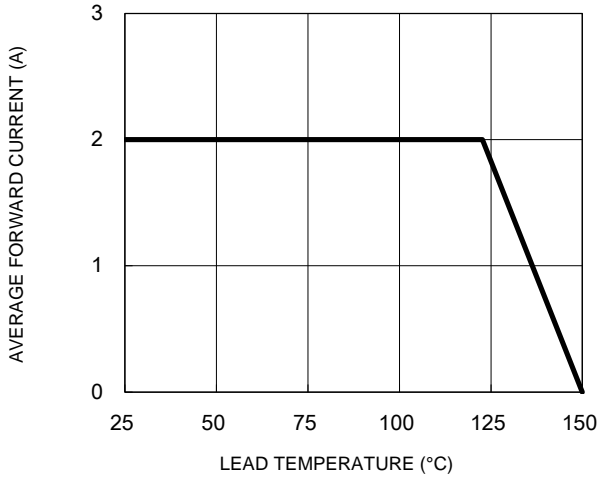


Fig.2 Typical Junction Capacitance

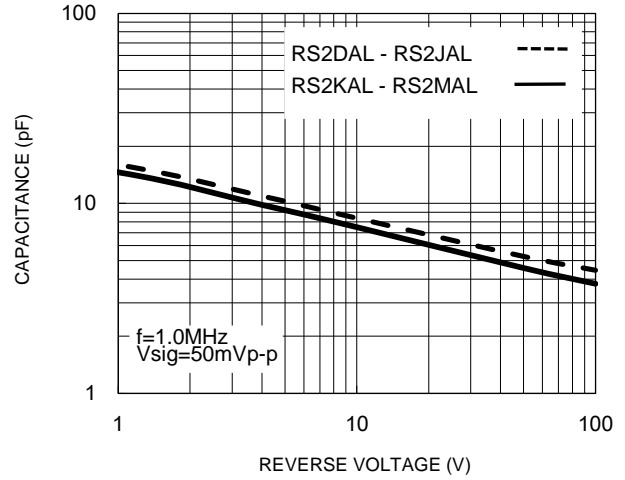


Fig.3 Typical Reverse Characteristics

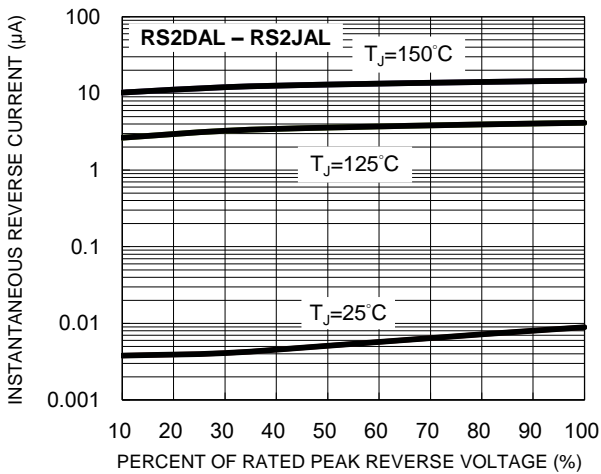


Fig.4 Typical Forward Characteristics

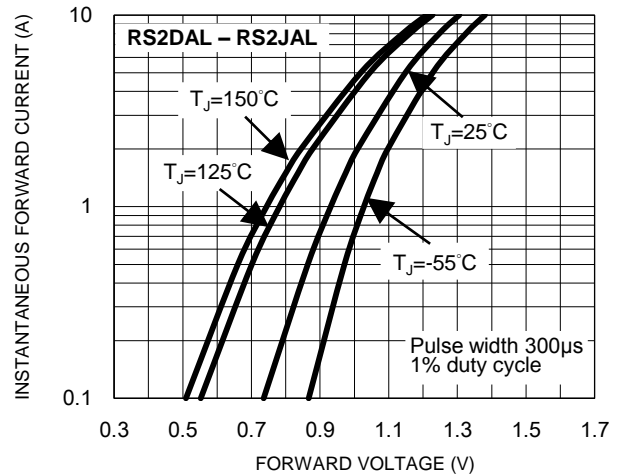


Fig.5 Typical Reverse Characteristics

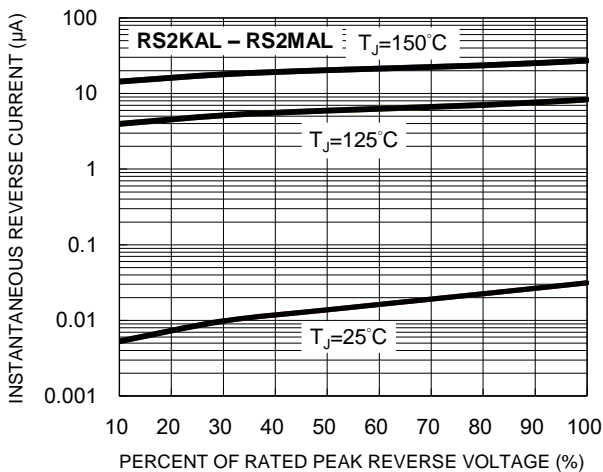
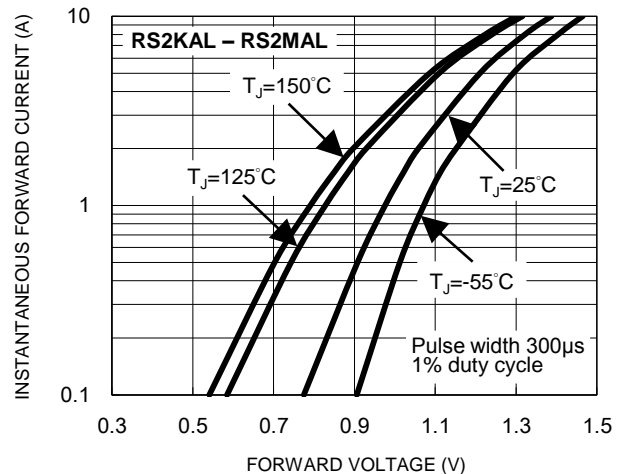


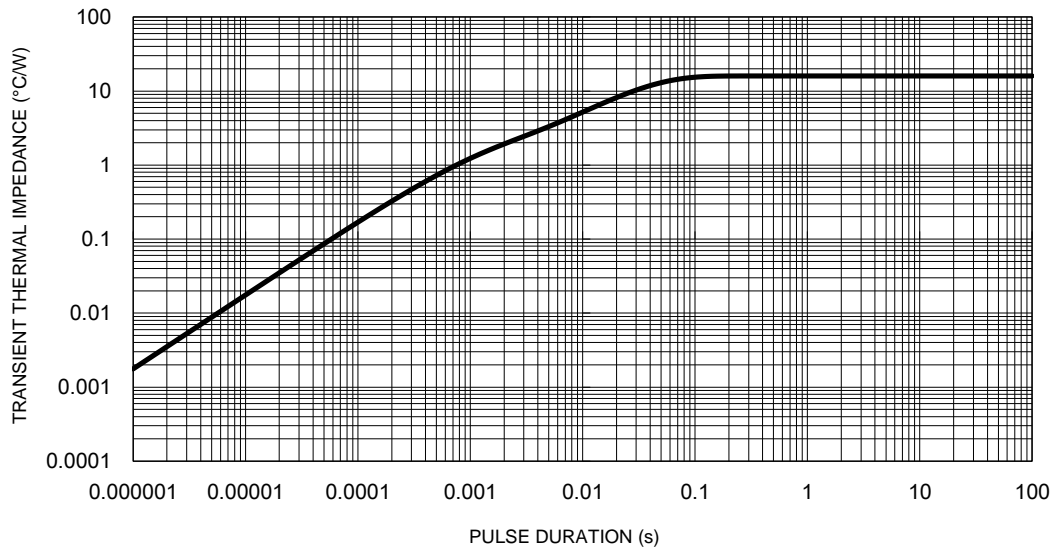
Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

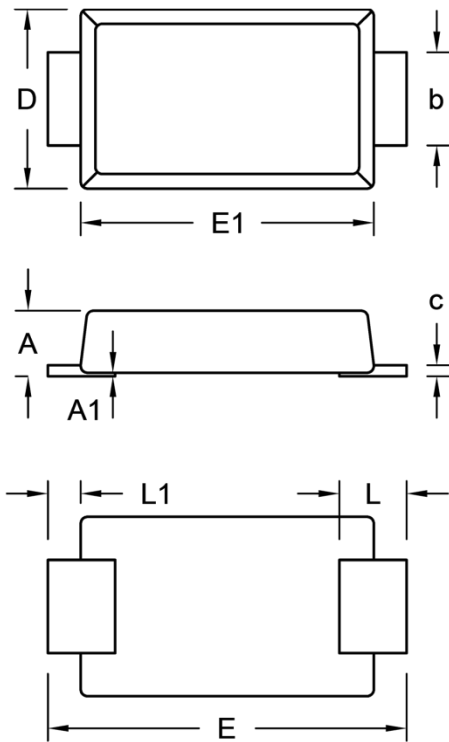
(T_A = 25°C unless otherwise noted)

Fig.7 Typical Transient Thermal Impedance



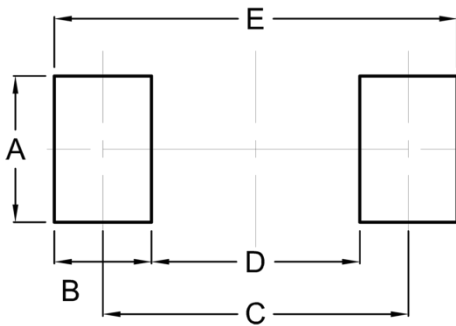
PACKAGE OUTLINE DIMENSIONS

Thin SMA



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
c	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
B	1.40	0.055
C	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code
 YW = Date Code
 F = Factory Code

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